Light Emitting Diodes

Panasonic

LNG422YKY

Round-Top View Type

 $\varphi 2.0\ mm$ Series

Absolute Maximum Ratings $T_a = 25 \pm 3^{\circ}C$

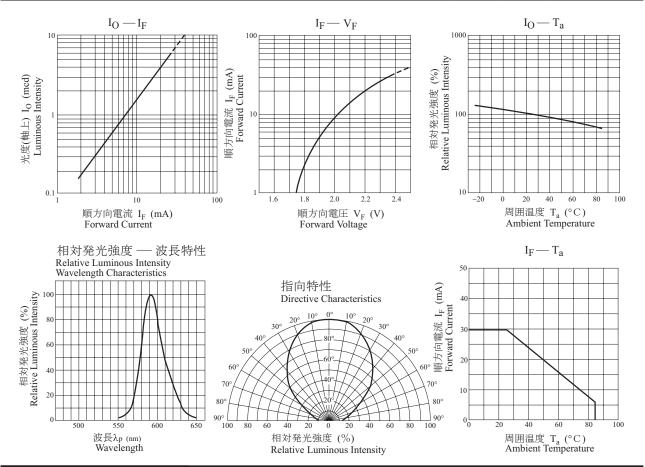
| Parameter | Symbol | Rating | Unit | |
|-------------------------------|------------------|-------------|------|--|
| Power dissipation | P _D | 90 | mW | |
| Forward current | I _F | 30 | mA | |
| Pulse forward current * | I _{FP} | 150 | mA | |
| Reverse voltage | V _R | 4 | V | |
| Operating ambient temperature | T _{opr} | -25 to +85 | °C | |
| Storage temperature | T _{stg} | -30 to +100 | °C | |

- Lighting Color / Lens Color
- Amber / Amber Diffused

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

Electro-Optical Characteristics $T_a = 25 \pm 3^{\circ}C$

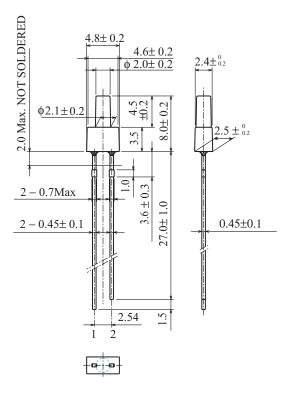
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--------------------------|-------------------|--------------------------------|-----|-----|-----|------|
| Luminous intensity | I _O | $I_{\rm F} = 20 \text{ mA DC}$ | 1.5 | 4.0 | | mcd |
| Forward voltage | V _F | $I_{\rm F} = 20 \text{ mA DC}$ | | 2.2 | 2.8 | V |
| Peak emission wavelength | $\lambda_{\rm P}$ | $I_{\rm F} = 20 \text{ mA DC}$ | | 590 | | nm |
| Spectral half band width | Δλ | $I_{\rm F} = 20 \text{ mA DC}$ | | 30 | | nm |
| Reverse current | I _R | $V_R = 4 V$ | | | 10 | μΑ |



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Package (Unit: mm)



• Pin name

1: Anode

2: Cathode

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